
Low Capacitance Bi-directional TVS

Compliance Standard

- ◆ IEC 61000-4-2 (ESD)
20KV - Contact Discharge
25KV - Air Discharge
- ◆ IEC 61000-4-4 (EFT) 40A (5/50ns)
- ◆ IEC 61000-4-5 (Surge) 4.0 (8/20us)

Applications

- ◆ Data Interface Protection
- ◆ Embedded System
- ◆ Handheld Device
- ◆ Computer

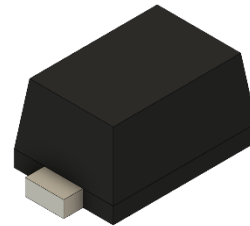
Features

- ◆ 50W Peak Pulse Power
- ◆ Low Clamping Voltage
- ◆ Low Leakage Current
- ◆ Single Line, Bi-Directional

Mechanical Characteristics

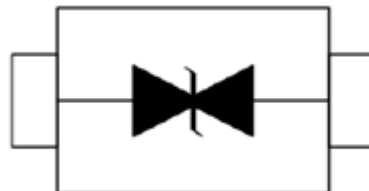
- ◆ SOD-523 Package
- ◆ Weight 2 Milligram (Approximate)
- ◆ Flammability Rating UL94V-0
- ◆ Lead Free Plating
- ◆ Reel Size 7"
- ◆ 3000 PCS Per Reel

Package



SOD-523

Pin Configuration



DEVICE CHARACTERISTICS

Maximum Rating			
Parameter	Symbol	Value	Unit
Peak Pulse Power	P _{PP}	50	Watt
Lead Soldering Temperature	T _L	260 (10s)	°C
Operating Temperature Range	T _J	-55~150	°C
Storage Temperature Range	T _{STG}	-55~150	°C

Electrical Characteristics (@25 °C)							
Part Number	Marking	V _{RWM} (Volt)	V _B (Volt)	V _C (Volt)	I _{PP} (A)	I _R (uA)	C _J (pF)
NLULC05CT	U3P	5.0	6.0	13.0	4.0	1.0	0.2

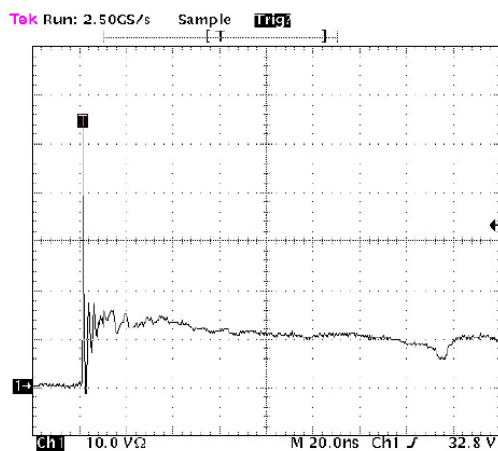


Figure1. Clamping waveform of positive 8KV ESD contact

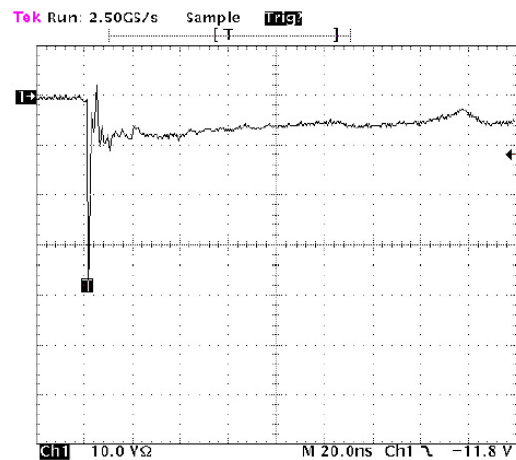
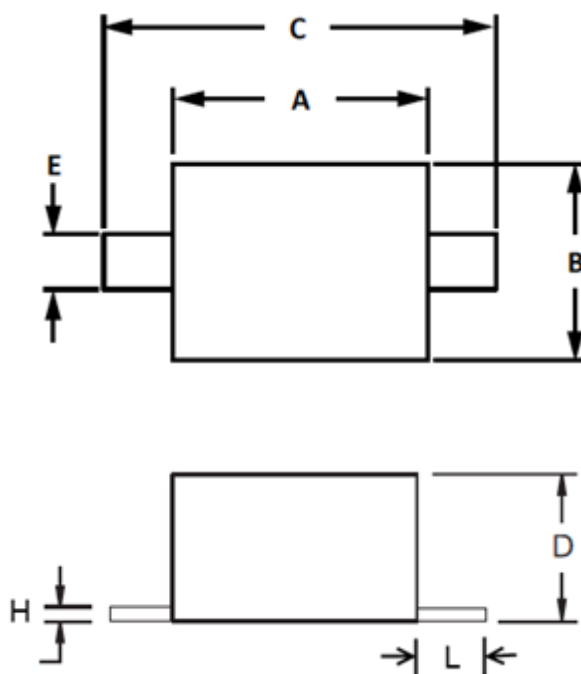


Figure2. Clamping waveform of negative 8KV ESD contact

DEVICE OUTLINE

<i>Outline Dimension</i>				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	1.10	1.30	0.043	0.051
B	0.70	0.90	0.028	0.035
C	1.50	1.70	0.059	0.067
D	0.50	0.70	0.020	0.028
E	0.25	0.35	0.010	0.014
H	0.07	0.20	0.0028	0.0079
L	0.15	0.25	0.006	0.010



LAYOUT PAD DIMENSION

<i>Layout PAD Dimension</i>				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	1.80	2.00	0.071	0.079
B	0.40	0.42	0.016	0.017
C	0.40	0.50	0.016	0.020



<i>Revision History</i>	<i>Description</i>
v2.0	Re-organize datasheet layout